

ShenZhen ChipSourceTek Technology Co. , Ltd.

### XYT1496A 600KHz, 18V, 2A Synchronous Step-Down Converter

#### XYT1496A FEATURES

- High Efficiency: Up to 98%
- 600KHz Frequency Operation
- 2A Output Current
- No Schottky Diode Required
- 4.0V to 18V Input Voltage Range
- 0.6V Reference
- Slope Compensated Current Mode Control for Excellent Line and Load Transient Response
- Integrated internal compensation
- Stable with Low ESR Ceramic Output Capacitors
- Over Current Protection with Hiccup-Mode
- Thermal Shutdown
- Inrush Current Limit and Soft Start
- Available in SOT23-6 Package
- -40°C to +85°C Temperature Range

#### XYT1496A APPLICATIONS

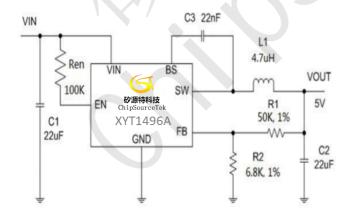
- Distributed Power Systems
- Digital Set Top Boxes
- Flat Panel Television and Monitors
- Wireless and DSL Modems
- Notebook Computer

VOUT

#### **XYT1496A GENERAL DESCRIPTION**

The XYT1496A is a fully integrated, high efficiency 2A synchronous rectified stepdown converter. The XYT1496A operates at high efficiency over a wide output current load range. This device offers two operation modes, PWM control and PFM Mode switching control, which allows a high efficiency over the wider range of the load. The XYT1496A requires a minimum number of readily available standard external components and is available in a 6-pin SOT23-6 compliant package.

#### XYT1496A TYPICAL APPLICATION



V 0 0 1	1 \ 1	1 1/2
5.0V	50K	6.8K
3.3V	50K	11K
1.8V	50K	25K
1.5V	50K	33.3K
1.2V	50K	50K
1.0V	50K	75K
•		

R1

Figure 1. Basic Application Circuit for VOUT=5V

The recommended divider resistor setup for the output voltage

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## XYT1496A ABSOLUTE MAXIMUM RATINGS (Note 1)

VIN, EN Voltage ..... -0.3V to 20V Operating Temperature Range ... -40°C to +85°C F B V o I t a g e s ... ... - 0 . 3 t o 6 V Lead Temperature (Soldering, 10s) .....+300°C

SW Voltage .....-0.3V to (VIN+0.5V) Storage Temperature Range ......-65°C to 150°C BS Voltage ..... (Vsw-0.3) to (Vsw+5V)

#### **XYT1496A PIN DESCRIPTION**

PIN	NAME	FUNCTION			
1	BS	Bootstrap. A capacitor connected between SW and BST pins is required to form a floating supply across the high-side switch driver.			
2	GND	GROUND Pin			
3	FB	Adjustable Version Feedback input. Connect FB to the center point of the external resistor divider			
4	EN	Drive this pin to a logic-high to enable the IC. Drive to a logic-low to disable the IC and enter micro-power shutdown mode.			
5	IN	Power Supply Pin			
6	SW	Switching Pin			

#### XYT1496A PIN CONFIGURATION



XYT1496A(SOT23-6)



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## XYT1496A ELECTRICAL CHARACTERISTICS (Note 3)

(VIN=12V, VOUT=5V, TA = 25°C, unless otherwise noted.)

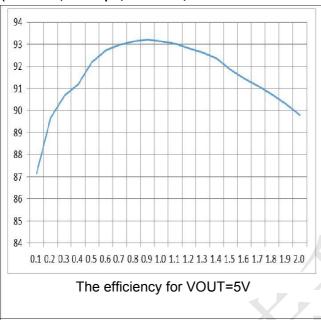
Parameter	Conditions	MIN	TYP	MAX	unit
Input Voltage Range		4		18	V
Supply Current in Operation	V <sub>EN</sub> =3.0V, V <sub>FB</sub> =1.1V		0.4	0.8	mA
Supply Current in Shutdown	V <sub>EN</sub> =0 or EN = GND	<b>~</b>	5		uA
Regulated Feedback Voltage	T <sub>A</sub> = 25°C, 4.5V≤VIN ≤18V	0.588	0.6	0.612	V
High-Side Switch On-Resistance			90	< (	mΩ
Low-Side Switch On-Resistance			70		mΩ
High-Side Switch Leakage Current	Ven=0V, Vsw=0V		0	10	uA
Upper Switch Current Limit	Minimum Duty Cycle		3		А
Oscillation Frequency			0.6		MHz
Maximum Duty Cycle	V <sub>FB</sub> =0.6V		92		%
Minimum On-Time			60		nS
Minimum Off-Time			100		nS
Thermal Shutdown			160		°C
Thermal Shutdown Hysistersis			20		°C

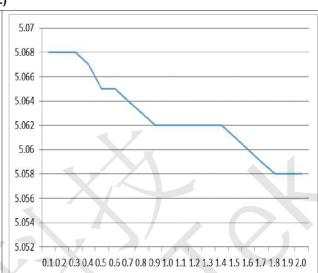


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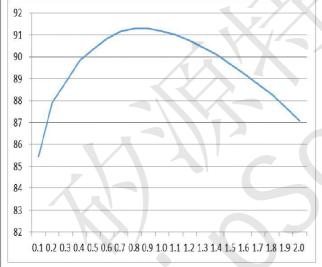
#### XYT1496A TYPICAL PERFORMANCE CHARACTERISTICS

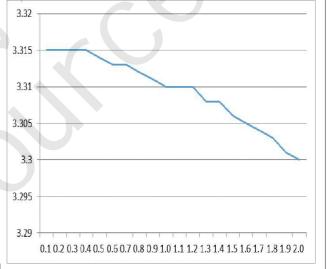
(VIN = 12V, L = 4.7μH, TA = 25°C, unless otherwise noted.)









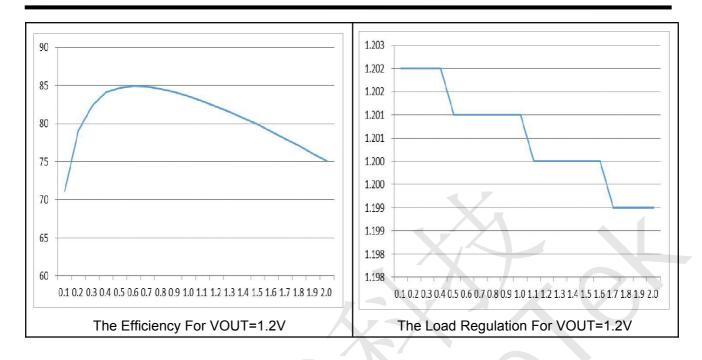


The efficiency for VOUT=3.3V

The Load Regulation For VOUT=3.3V



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#### XYT1496A FUNCTIONAL BLOCK DIAGRAM

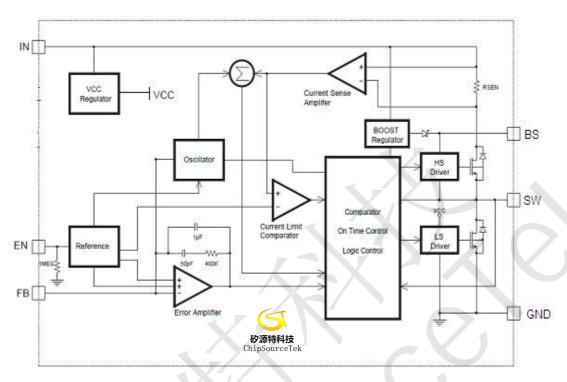


Figure 2. XYT1496A Block Diagram

#### XYT1496A FUNCTIONAL DESCRIPTION

### **Internal Regulator**

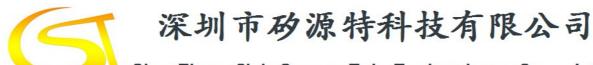
The XYT1496A is a current mode step down DC/DC converter that provides excellent transient response with no extra external compensation components. This device contains an internal, low resistance, high voltage power MOSFET, and operates at a high 600K operating frequency to ensure a compact, high efficiency design with excellent AC and DC performance.

### **Error Amplifier**

The error amplifier compares the FB pin voltage with the internal FB reference (VFB) and outputs a current proportional to the difference between the two. This output current is then used to charge or discharge the internal compensation network to form the COMP voltage, which is used to control the power MOSFET current. The optimized internal compensation network minimizes the external component counts and simplifies the control loop design.

#### Internal Soft-Start

The soft-start is implemented to prevent the converter output voltage from overshooting during startup. When the chip starts, the internal circuitry generates a soft-start voltage (SS) ramping up from 0V to 0.81V. When it is lower than the internal reference (REF), SS overrides REF so the error amplifier uses SS as the reference. When SS is higher than REF, REF regains control. The SS time is internally fixed to 1.5 ms.



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### **Over Current Protection & Hiccup**

The XYT1496A has cycle-by-cycle over current limit when the inductor current peak value exceeds the set current limit threshold. Meanwhile, output voltage starts to drop until FB is below the Under-Voltage (UV) threshold, typically 30% below the reference. Once a UV is triggered, the XYT1496A enters hiccup mode periodically restart the part. This protection mode is especially useful when the output is dead-short to ground. The average short circuit current is greatly reduced to alleviate the thermal issue and to protect the regulator. The XYT1496A exits the hiccup mode once the over condition is removed.

### Startup and Shutdown

If both VIN and EN are higher than their appropriate thresholds, the chip starts. The reference block starts first, generating stable reference voltage and currents, and then the internal regulator is enabled. The regulator provides stable supply for the remaining circuitries. Three events can shut down the chip: EN low, VIN low and thermal shutdown. In the shutdown procedure, the signaling path is first blocked to avoid any fault triggering. The COMP voltage and the internal supply rail are then pulled down. The floating driver is not subject to this shutdown command.

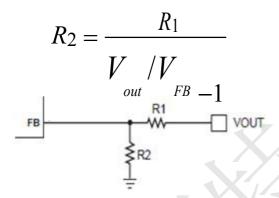


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#### XYT1496A APPLICATION INFORMATION

### **Setting the Output Voltage**

The external resistor divider is used to set the output voltage (see Typical Application on page 1). The feedback resistor R1 also sets the feedback loop bandwidth with the internal compensation capacitor. Choose R1 to be around  $50k\Omega$  for optimal transient response. R2 is then given by:



### Selecting the Inductor

A 4.7 $\mu$ H to 22 $\mu$ H inductor with a DC current rating of at least 25% percent higher than the maximum load current is recommended for most applications. For highest efficiency, the inductor DC resistance should be less than 15m $\Omega$ . For most designs, the inductance value can be derived from the following equation.

$$L = \frac{V \times (V - V)}{V \times \Delta I \times f_{OSC}}$$

Where  $\Delta IL$  is the inductor ripple current. Choose inductor ripple current to be approximately 30% if the maximum load current, 2A. The maximum inductor peak current is:

$$I_{L(MAX)} = I_{LOAD} + \frac{\Delta I_L}{2}$$

Under light load conditions below 100mA, larger inductance is recommended for improved efficiency.

### **Selecting the Output Capacitor**

The output capacitor (C2) is required to maintain the DC output voltage. Ceramic, tantalum, or low ESR electrolytic capacitors are recommended. Low ESR capacitors are preferred to keep the output voltage ripple low. The output voltage ripple can be estimated by:

$$\Delta V_{OUT} = \frac{V}{OUT} \times \left[ 1 - \frac{V}{OUT} \right] \times \left[ R_{ESR} + \frac{1}{8 \times f_S \times C_2} \right]$$

$$f_S \times L \quad \left[ V_{IN} \right] \quad \left[ 8 \times f_S \times C_2 \right]$$

Where L is the inductor value and RESR is the equivalent series resistance (ESR) value of the output capacitor. In the case of ceramic capacitors, the impedance at the switching frequency is dominated by the capacitance. The output voltage ripple is mainly caused by the capacitance. For simplification, the output voltage ripple can be estimated by:

$$\Delta V_{OUT} = \frac{V}{2} \times \left[ 1 - \frac{V}{0UT} \right]$$

$$8 \times f_S \times L \times C_2$$

$$| N |$$

In the case of tantalum or electrolytic capacitors, the ESR dominates the impedance at the switching frequency. For simplification, the output ripple can be approximated to:

$$\Delta V_{OUT} = \frac{V_{OUT} | V_{OUT}|}{f_{S} \times L} \times 1 - \frac{V_{OUT}}{V_{IN}} \times R_{ESR}$$

The characteristics of the output capacitor also affect the stability of the regulation system. The XYT1496A can be optimized for a wide range of capacitance and ESR values.



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### XYT1496A PCB Layout Guide

PCB layout is very important to achieve stable operation. It is highly recommended to duplicate EVB layout for optimum performance. If change is necessary, please follow these guidelines and take Figure 4 for reference.

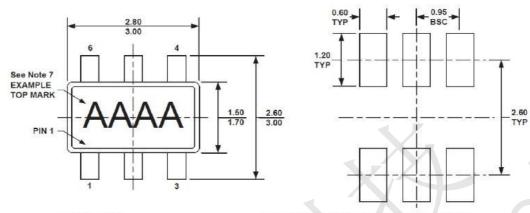
- 1) Keep the path of switching current short and minimize the loop area formed by Input capacitor, high-side MOSFET and low-side MOSFET.
- 2) Bypass ceramic capacitors are suggested to be put close to the Vin Pin.

- 3) Ensure all feedback connections are short and direct. Place the feedback resistors and compensation components as close to the chip as possible.
- 4) VOUT, SW away from sensitive analog areas such as FB.
- 5) Connect IN, SW, and especially GND respectively to a large copper area to cool the chip to improve thermal performance and long-term reliability.
- 6) An example of 2-layer PCB layout is shown in Figure 4 for reference.



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#### **XYT1496A PACKAGE INFORMATION**



**TOP VIEW** 

RECOMMENDED LAND PATTERN

